



WASHINGTON INTERNSHIPS FOR STUDENTS OF ENGINEERING (WISE) 2018 Summer Program (3 June – 4 August)

Application Instructions

Applicant must be:

- (1) a Junior or Senior engineering or computer science/ engineering student, or a recent engineering graduate beginning study in a graduate-level, technology policy-related program;
- (2) a citizen or legal permanent resident of the United States; and
- (3) a student (or higher grade) member of the Institute of Electrical and Electronics Engineers (IEEE).

Only completed applications will be considered. A complete application includes:

- (1) A completed application form (two pages and two essays);
- (2) A copy of your official transcript(s); and
- (3) TWO letters of reference (at least one of which must be from an engineering faculty member who supervised your work).

Submit your application by mail, email or fax to:

IEEE WISE
2001 L Street, N.W., Suite 700
Washington, DC 20036
Attn: Diana Librizzi
Email: d.librizzi@ieee.org

Deadline: All materials must be postmarked by **31 December 2017**

For more information, visit the WISE Home Page at:

<http://www.wise-intern.org>



**APPLICATION FOR WASHINGTON INTERNSHIPS
FOR STUDENTS OF ENGINEERING (WISE)
(Please type or print in black ink)**

Name _____

College Address _____

Home Address _____

Cell Phone _____

Social Security Number_ (For housing purposes and purposes of arranging meetings in federal facilities,
this information must be provided.)

Citizenship _____ DOB _____

E-Mail Address _____

Emergency Contact _____

University in which enrolled _____

Expected date of graduation _____

Major _____

Special areas of interest _____

GPA (overall) _____ GPA (major field) _____

IEEE Student Member # _____

How did you find out about the WISE Program? _____

Indicate TWO persons from whom references were requested:

1) Name _____

Professional Address _____

Telephone _____

2) Name _____

Professional Address _____

Telephone _____



REFERENCE INFORMATION REQUEST

Each summer the WISE program brings undergraduate engineering students to Washington, D.C. to learn more about the relationship between government and the technical community. Interns attend meetings with policy makers and complete a topic paper on a specific engineering-public policy issue of interest to both the student and the sponsoring organization. As part of the selection process, each applicant is requested to have two references to be included in his/her file.

Name of Applicant _____

Last

First

Name of Reference _____

Last

First

Title _____

Department _____

Address _____

1. NARRATIVE COMMENTS: (Please type or print in black ink. Attach additional pages if desired.).

(OVER)

2. QUALIFICATIONS: I would compare this student with others on a peer level as follows:

- a. **QUALITY OF ACADEMIC WORK**
 EXCELLENT GOOD FAIR POOR
- b. **COMMUNICATION SKILLS (ORAL):**
 EXCELLENT GOOD FAIR POOR
- c. **COMMUNICATION SKILLS (WRITTEN):**
 EXCELLENT GOOD FAIR POOR
- d. **INTERPERSONAL SKILLS:**
 EXCELLENT GOOD FAIR POOR
- e. **LEADERSHIP ABILITIES:**
 EXCELLENT GOOD FAIR POOR
- f. **MOTIVATION:**
 EXCELLENT GOOD FAIR POOR
- g. **MATURITY:**
 EXCELLENT GOOD FAIR POOR

STATEMENT OF CONFIDENTIALITY

- My preparation of this reference is conditioned on the promise of WISE to hold my identity as author of these comments in confidence.
- My preparation of this reference is NOT conditioned on the promise of WISE to hold my identity as author of these comments in confidence.

Signature of Respondent _____ Date _____

RETURN COMPLETED REFERENCE TO:

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APPLICATION DEADLINE

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